



# Product Change Notification

**Change Notification #:** 119008-00  
**Change Title:** Select Intel® SSD D5-P5316 Series SKUs,  
PCN 119008-00, Product Material,  
Add second source component  
**Date of Publication:** May 02, 2022

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material</b>	July 08, 2022
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## Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- All SKUs adding the following alternate component:

Component	Use Case	Current Source Manufacturer (Part Number)	Second Source Manufacturer (Part Number)
MOSFET	SMBUS isolation and level shifter FETs	On Semi (G50657-001)	Toshiba (M67972-001)
MOSFET	Sideband signal MOSFET for dual port and CLKREQ functionality	Toshiba (K54006-001)	Nexperia (M77415-001)
		Diodes (H95739-001)	
Circuit Protection Diode	UART debug connector 5V TVS diode	On Semi (E76666-001)	Nexperia (M70252-001)
Diode Array Schottky	Sideband signal diode for dual port and CLKREQ functionality	On Semi (J82424-001)	Panjit (M74156-001)
		On Semi (E11457-001)	
eFuse – Voltage Protection	12V host effuse for soft start and input current limiting	TI (K60448-002)	Silergy (M75765-001)

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD D5 P5316 Series (15.3TB, 2.5in PCIe 4.0 x4, 3D4, QLC) Generic No OPAL Single Pack	SSDPF2NV153TZN1	99AA1N
Intel® SSD D5 P5316 Series (30.7TB, 2.5in PCIe 4.0 x4, 3D4, QLC) Generic No OPAL Single Pack	SSDPF2NV307TZN1	99AA1P
Intel® SSD D5 P5316 Series (15.3TB, EDSFF L 9.5mm PCIe 4.0 x4, 3D4, QLC) Generic No OPAL Single Pack	SSDPFWNV153TZN1	99AA1T
Intel® SSD D5 P5316 Series (30.7TB, EDSFF L 9.5mm PCIe 4.0 x4, 3D4, QLC) Generic No OPAL Single Pack	SSDPFWNV307TZN1	99AA1V

## PCN Revision History:

**Date of Revision:**

May 02, 2022

**Revision Number:**

00

**Reason:**

Originally Published PCN



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## 119008-00

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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

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